

Switching Transistor

PNP Silicon

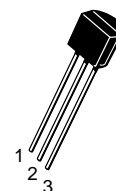
MPS3638A

MAXIMUM RATINGS

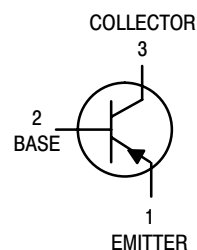
Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	–25	Vdc
Collector–Emitter Voltage	V_{CES}	–25	Vdc
Collector–Base Voltage	V_{CBO}	–25	Vdc
Emitter–Base Voltage	V_{EBO}	–4.0	Vdc
Collector Current — Continuous	I_C	–500	mA _{dc}
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	625 5.0	mW mW/ $^\circ\text{C}$
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	1.5 12	Watts mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	–55 to +150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}^{(1)}$	200	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case	$R_{\theta JC}$	83.3	$^\circ\text{C/W}$



CASE 29–11, STYLE 1
TO–92 (TO–226AA)



ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector–Emitter Breakdown Voltage ($I_C = -100\ \mu\text{A}_{dc}$, $V_{BE} = 0$)	$V_{(BR)CES}$	–25	—	Vdc
Collector–Emitter Sustaining Voltage ⁽²⁾ ($I_C = -10\ \text{mA}_{dc}$, $I_B = 0$)	$V_{CEO(sus)}$	–25	—	Vdc
Collector–Base Breakdown Voltage ($I_C = -100\ \mu\text{A}_{dc}$, $I_E = 0$)	$V_{(BR)CBO}$	–25	—	Vdc
Emitter–Base Breakdown Voltage ($I_E = -100\ \mu\text{A}_{dc}$, $I_C = 0$)	$V_{(BR)EBO}$	–4.0	—	Vdc
Collector Cutoff Current ($V_{CE} = -15\ \text{Vdc}$, $V_{BE} = 0$) ($V_{CE} = -15\ \text{Vdc}$, $V_{BE} = 0$, $T_A = -65^\circ\text{C}$)	I_{CES}	— —	–0.035 –2.0	μA_{dc}
Emitter Cutoff Current ($V_{EB} = -3.0\ \text{V}$, $I_C = 0$)	I_{EBO}	—	–35	nA
Base Current ($V_{CE} = -15\ \text{Vdc}$, $V_{BE} = 0$)	I_B	—	–0.035	μA_{dc}

1. $R_{\theta JA}$ is measured with the device soldered into a typical printed circuit board.

2. Pulse Test: Pulse Width $\leq 300\ \mu\text{s}$; Duty Cycle $\leq 2.0\%$.

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ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted) (Continued)

Characteristic	Symbol	Min	Max	Unit
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ON CHARACTERISTICS⁽²⁾

DC Current Gain ($I_C = -1.0\text{ mA}$, $V_{CE} = -10\text{ Vdc}$) ($I_C = -10\text{ mA}$, $V_{CE} = -10\text{ Vdc}$) ($I_C = -50\text{ mA}$, $V_{CE} = -1.0\text{ Vdc}$) ($I_C = -300\text{ mA}$, $V_{CE} = -2.0\text{ Vdc}$)	h_{FE}	80 100 100 20	— — — —	—
Collector–Emitter Saturation Voltage ($I_C = -50\text{ mA}$, $I_B = -2.5\text{ mA}$) ($I_C = -300\text{ mA}$, $I_B = -30\text{ mA}$)	$V_{CE(sat)}$	— —	–0.25 –1.0	Vdc
Base–Emitter Saturation Voltage ($I_C = -50\text{ mA}$, $I_B = -2.5\text{ mA}$) ($I_C = -300\text{ mA}$, $I_B = -30\text{ mA}$)	$V_{BE(sat)}$	— –0.80	–1.1 –2.0	Vdc

SMALL–SIGNAL CHARACTERISTICS

Current–Gain — Bandwidth Product ($V_{CE} = -3.0\text{ Vdc}$, $I_C = -50\text{ mA}$, $f = 100\text{ MHz}$)	f_T	150	—	MHz
Output Capacitance ($V_{CB} = -10\text{ Vdc}$, $I_E = 0$, $f = 1.0\text{ MHz}$)	C_{obo}	—	10	pF
Input Capacitance ($V_{EB} = -0.5\text{ Vdc}$, $I_C = 0$, $f = 1.0\text{ MHz}$)	C_{ibo}	—	25	pF
Input Impedance ($I_C = -10\text{ mA}$, $V_{CE} = -10\text{ Vdc}$, $f = 1.0\text{ kHz}$)	h_{ie}	—	2000	k Ω
Voltage Feedback Ratio ($I_C = -10\text{ mA}$, $V_{CE} = -10\text{ Vdc}$, $f = 1.0\text{ kHz}$)	h_{re}	—	15	$\times 10^{-4}$
Small–Signal Current Gain ($I_C = -10\text{ mA}$, $V_{CE} = -10\text{ Vdc}$, $f = 1.0\text{ kHz}$)	h_{fe}	100	—	—
Output Admittance ($I_C = -10\text{ mA}$, $V_{CE} = -10\text{ Vdc}$, $f = 1.0\text{ kHz}$)	h_{oe}	—	1.2	mmhos

SWITCHING CHARACTERISTICS

Delay Time	(V _{CC} = –10 Vdc, I _C = –300 mA, I _{B1} = –30 mA)	t _d	—	20	ns
Rise Time		t _r	—	70	ns
Storage Time	(V _{CC} = –10 Vdc, I _C = –300 mA, I _{B1} = –30 mA, I _{B2} = –30 mA)	t _s	—	140	ns
Fall Time		t _f	—	70	ns
Turn–On Time	(I _C = –300 mA, I _{B1} = –30 mA)	t _{on}	—	75	ns
Turn–Off Time	(I _C = –300 mA, I _{B1} = –30 mA, I _{B2} = 30 mA)	t _{off}	—	170	ns

2. Pulse Test: Pulse Width $\leq 300\text{ }\mu\text{s}$; Duty Cycle $\leq 2.0\%$.

SWITCHING TIME EQUIVALENT TEST CIRCUIT

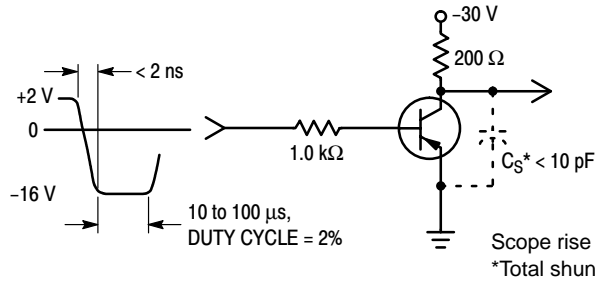


Figure 1. Turn-On Time

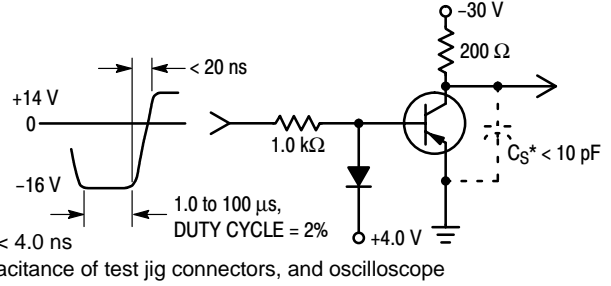


Figure 2. Turn-Off Time

TRANSIENT CHARACTERISTICS

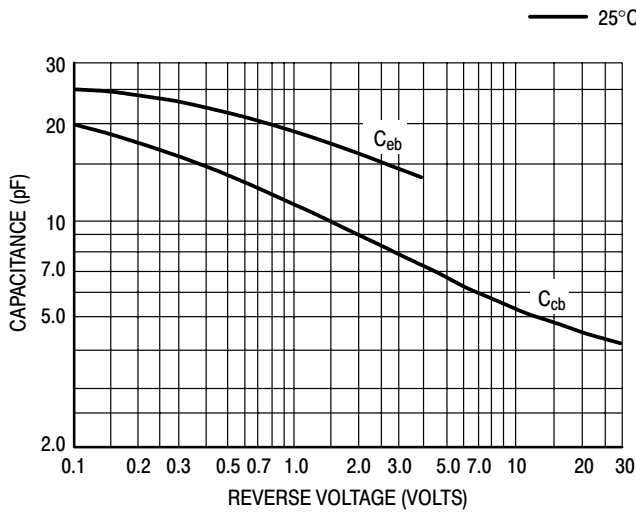


Figure 3. Capacitances

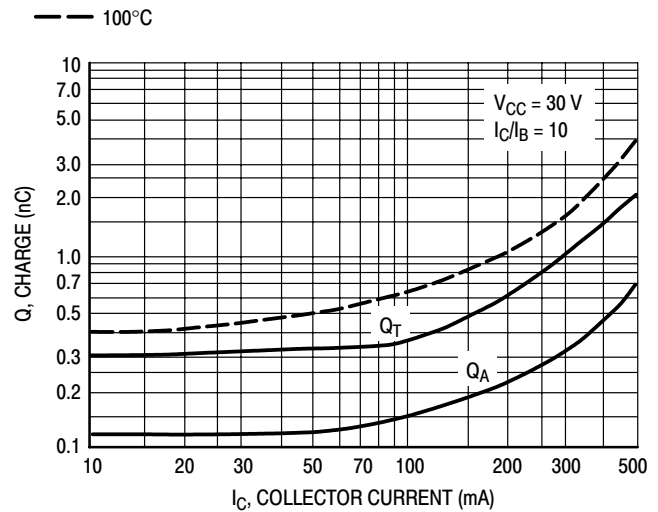


Figure 4. Charge Data

TRANSIENT CHARACTERISTICS (Continued)

— 25°C - - 100°C

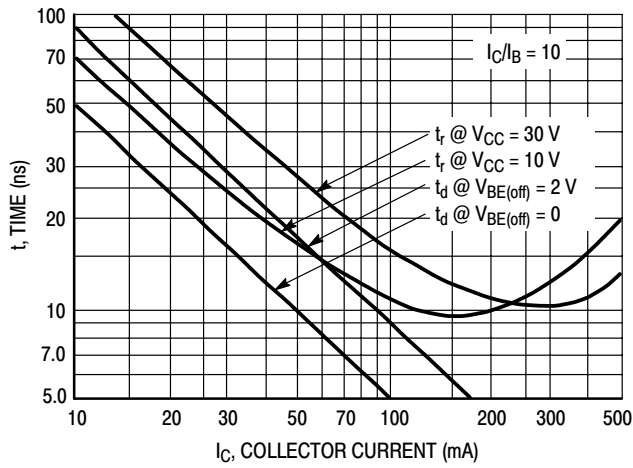


Figure 5. Turn-On Time

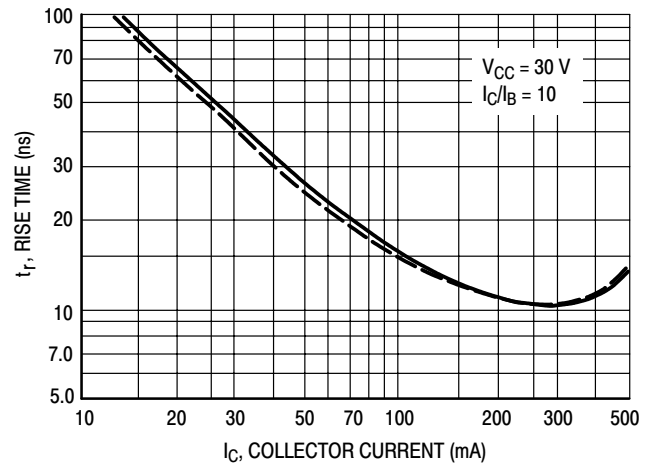


Figure 6. Rise Time

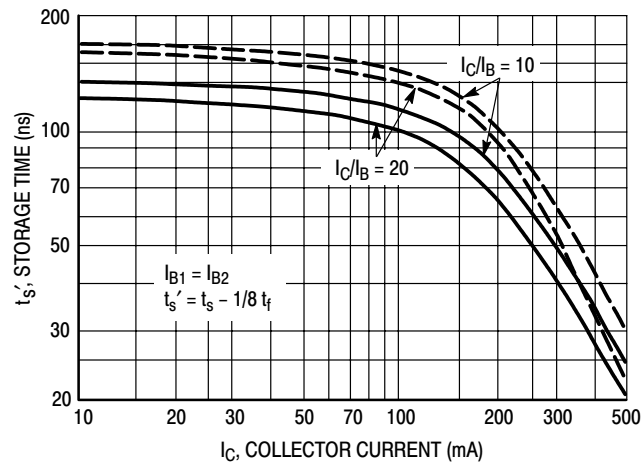


Figure 7. Storage Time

SMALL-SIGNAL CHARACTERISTICS

NOISE FIGURE

$V_{CE} = -10$ Vdc, $T_A = 25^\circ\text{C}$

Bandwidth = 1.0 Hz

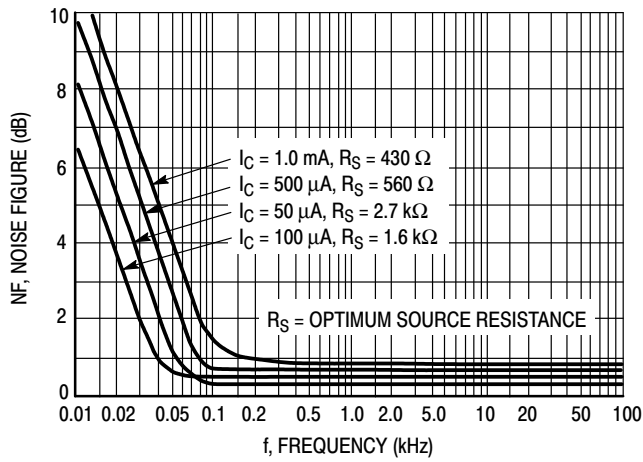


Figure 8. Frequency Effects

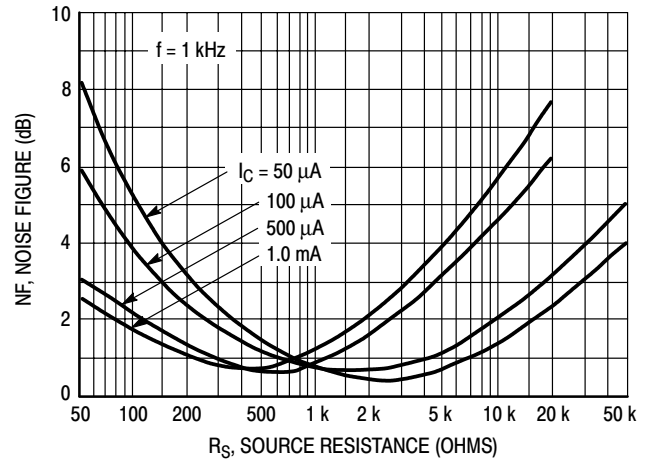


Figure 9. Source Resistance Effects

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h PARAMETERS

$$V_{CE} = -10 \text{ Vdc}, f = 1.0 \text{ kHz}, T_A = 25^\circ\text{C}$$

This group of graphs illustrates the relationship between h_{fe} and other “h” parameters for this series of transistors. To obtain these curves, a high-gain and a low-gain unit were

selected from the 2N4402 line, and the same units were used to develop the correspondingly-numbered curves on each graph.

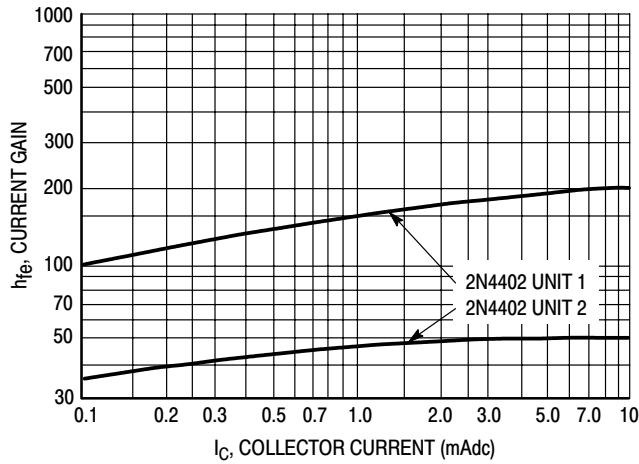


Figure 10. Current Gain

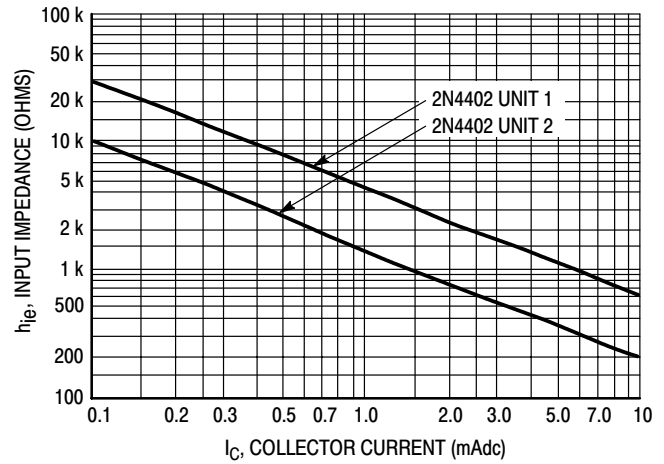


Figure 11. Input Impedance

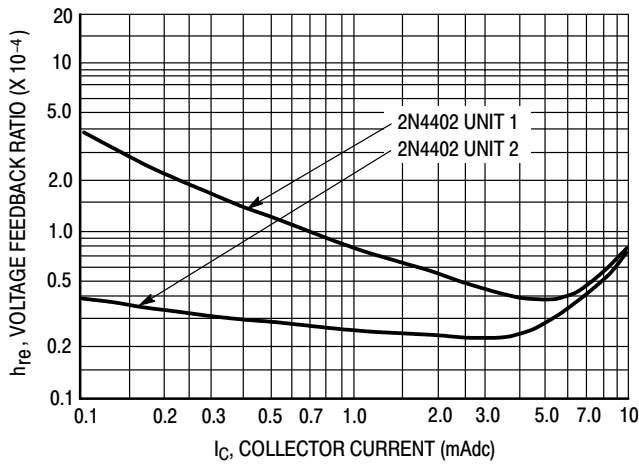


Figure 12. Voltage Feedback Ratio

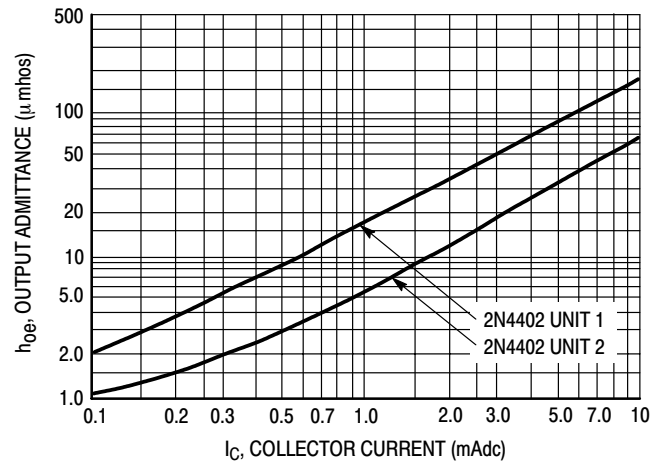


Figure 13. Output Admittance

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STATIC CHARACTERISTICS

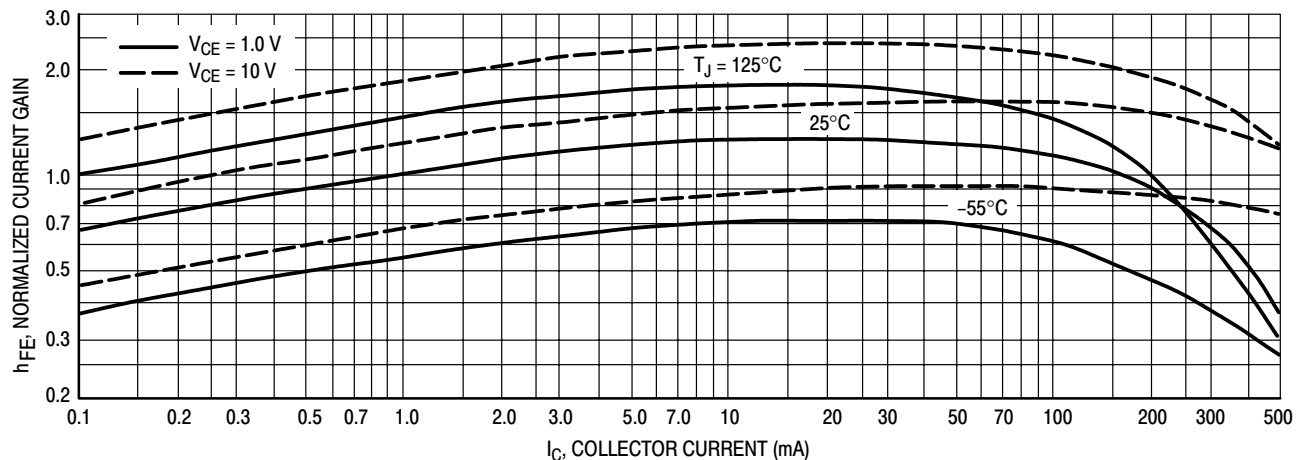


Figure 14. DC Current Gain

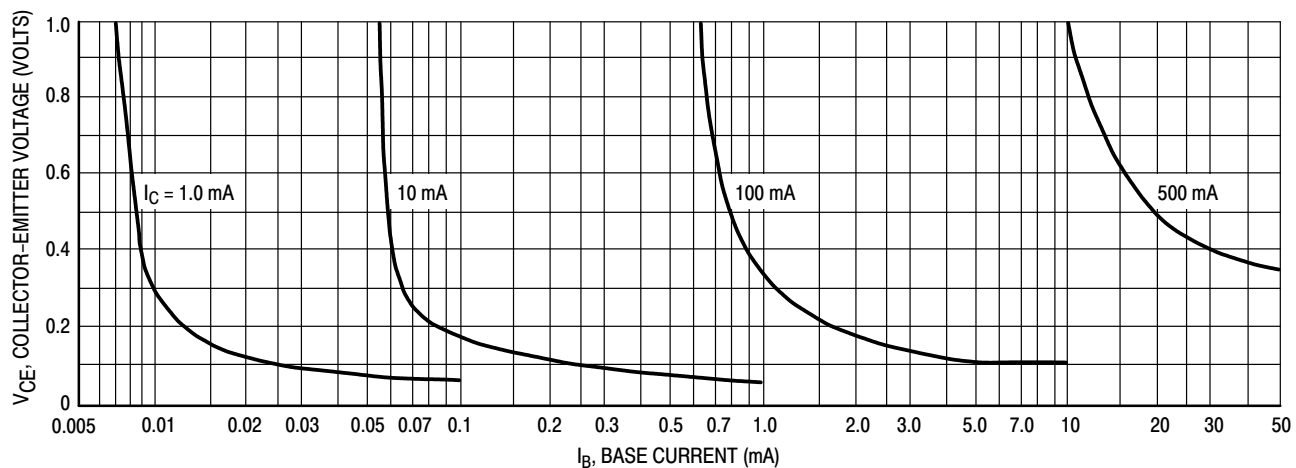


Figure 15. Collector Saturation Region

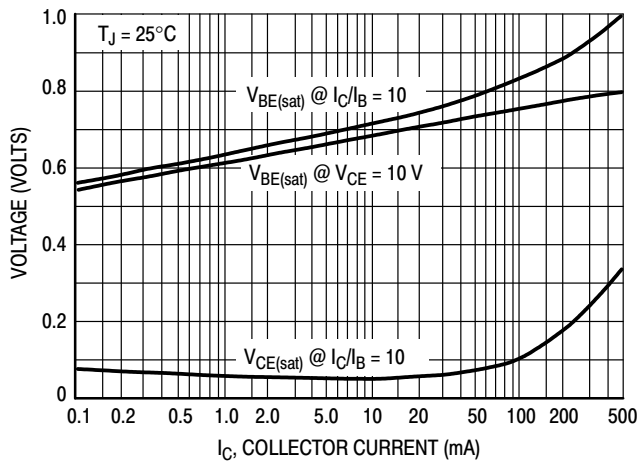


Figure 16. "On" Voltages

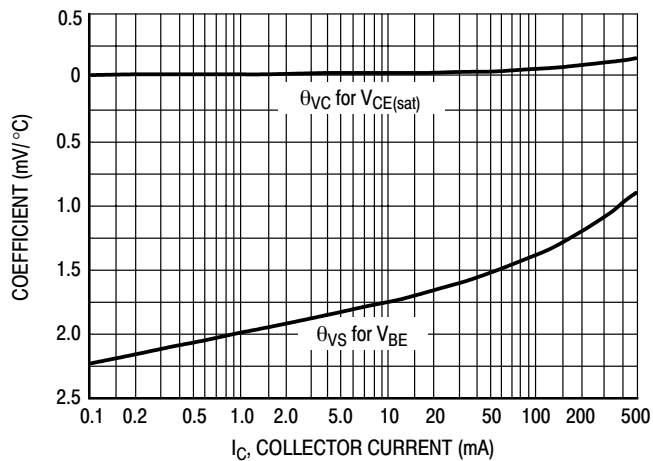
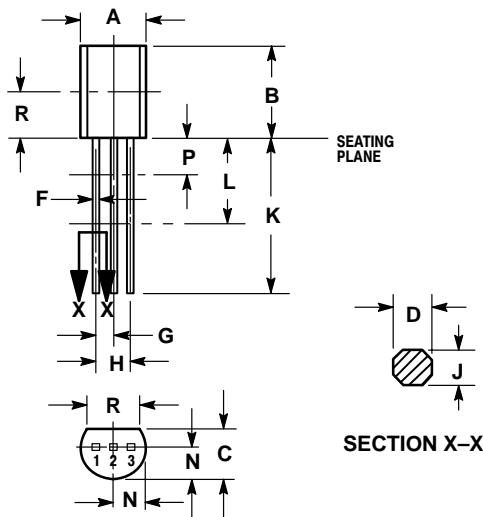


Figure 17. Temperature Coefficients

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PACKAGE DIMENSIONS

CASE 029-11
(TO-226AA)
ISSUE AD




STYLE 1:
PIN 1. EMITTER
2. BASE
3. COLLECTOR

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
4. DIMENSION F APPLIES BETWEEN P AND L. DIMENSIONS D AND J APPLY BETWEEN L AND K MINIMUM. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.175	0.205	4.44	5.21
B	0.290	0.310	7.37	7.87
C	0.125	0.165	3.18	4.19
D	0.018	0.021	0.457	0.533
E	0.016	0.019	0.407	0.482
F	0.045	0.055	1.15	1.39
G	0.095	0.105	2.42	2.66
H	0.018	0.024	0.46	0.61
I	0.500	---	12.70	---
J	0.250	---	6.35	---
K	0.080	0.105	2.04	2.66
L	---	0.100	---	2.54
M	0.135	---	3.43	---

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